



Power Project Board System has been designed to provide instant circuit construction without soldering on the bread board area .Learners can insert components directly on breadboard and make all interconnections as required with 24 Swg (Gauge) solid wire. Within few minutes they can complete their projects/design on the same.

Your precious IC's are not damaged & are instantly reusable, No expensive special jumpers are required. You can insert all components directly without any adapters i.e. IC's such as types 8, 14, 16, 20 or 40 pin DIP units, LSI's and all discrete components with lead diameter upto 0.56mm (24 Swg).

Features:

- Breadboard : Unique solder-less large size, spring loaded breadboard consisting of 3 Terminal Strips with 1920 tie points and 5 Distribution Strips with 500 tie points , totaling to 2420 tie points.
- Power Supply

Fixed DC Power Supply : 5 V at 1 Amp.

Variable DC Power Supply : ± 0 to 15 V at 500 mA

- Mains On/Off Illuminated Switch
- Accessories : Mains Lead, Operating Manual, Adequate no. of patch cords (Total 26)
- * The unit is operative on 230V $\pm 10\%$ at 50Hz A.C. Mains.
- * Good Quality, reliable terminal/sockets are provided at appropriate places on panel for connections & observation of waveforms.

Note: Specifications are subject to change.

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